NMOS LSI

# LM7007M, LM7007HM

# **Dual-PLL Frequency Synthesizers**

## **OVERVIEW**

The LM7007M and LM7007HM are dual-PLL frequency synthesizer ICs for use in 250 to 380 MHz cordless telephone transceivers.

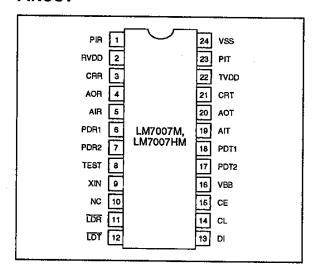
The LM7007M and LM7007HM comprise two PLL circuits, 16-bit transmit and receive programmable dividers, a temperature-compensated crystal oscillator (TCXO) amplifier and two transistors for external low-pass filters (LPF). Each PLL comprises a dual charge pump and fast-lockup circuit. The standard TCXO frequencies are 10.625, 12.8 and 21.25 MHz. Serial data transfer is controlled from a three-wire, serial, computer control bus (C<sup>2</sup>B).

The LM7007H and LM7007HM operate from a 2.8 to 4.5 V supply and are available in 24-pin MFPs.

## **FEATURES**

- Dual charge pump and fast-lockup circuit in each PLL for rapid locking
- 10.625, 12.8 and 21.25 MHz TCXO frequencies
- TCXO input amplifier
- Dual LPF transistors
- C<sup>2</sup>B serial interface
- 2.8 to 4.5 V supply
- 24-pin MFP

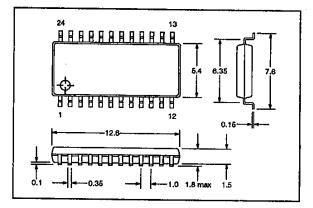
#### **PINOUT**



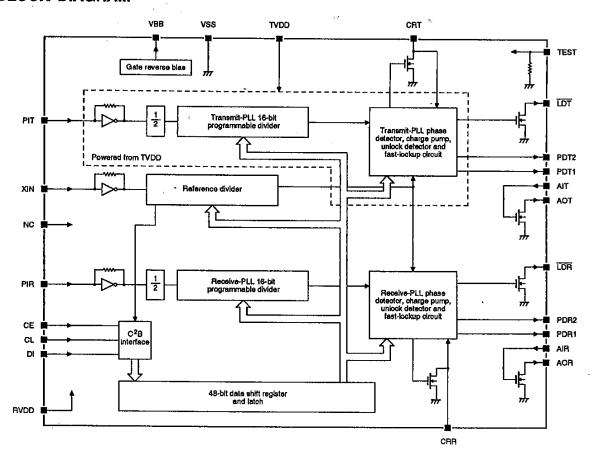
#### PACKAGE DIMENSIONS

Unit: mm

#### 3112-MFP24S



# BLOCK DIAGRAM



## PIN DESCRIPTION

Number	Name	Description
1	PIR	Receive-PLL local-oscillator input
2	RVDD	Receive-PLL 2.8 to 4.5 V supply
3	CRR	Receive-PLL fast-lockup circuit resistor and capacitor connection
4	AOR	Receive-PLL LPF, n-channel MOS transistor output
5	AIR	Receive-PLL LPF, n-channel MOS transistor input
6	PDR1	Receive-PLL phase detector main tristate output
7	PDR2	Receive-PLL phase detector secondary tristate output
8	TEST	Test input
9	XIN	Reference oscillator input
10	NC	No connection
11	LDR	Receive-PLL unlock detector n-channel, open-drain output
12	LDT	Transmit-PLL unlock detector n-channel, open-drain output
13	DI	Serial data input
14	CL	Clock input
15	CE	Chip enable input
16	VBB	Gale reverse-bias capacitor connection

## LM7007M, LM7007HM

Number	Name	Description
17	PDT2	Transmit-PLL phase detector secondary tristate output
18	PDT1	Transmit-PLL phase detector main tristate output
19	AIT	Transmit-PLL LPF, n-channel MOS transistor input
<sup>-</sup> 20	AOT	Transmit-PtL LPF, n-channel MOS transistor output
21	CRT ,	Transmit-PLL fast-lockup circuit resistor and capacitor connection
22	TVDD	Transmit-PLL 2.8 to 4.5 V supply
23	PIT	Transmit-PLL local-oscillator input
24	VSS	Ground

## **SPECIFICATIONS**

# **Absolute Maximum Ratings**

Parameter	Symbol	Rating	Unit
Receive-PLL supply voltage range	RV <sub>DD</sub>	0.3 to 5.5	V
Transmit-PLL supply voltage range	TV <sub>DD</sub>	-0.3 to 5.5	٧
Gate reverse-bias voltage range	V <sub>BB</sub>	-4 to −1	٧
XIN, TEST, PIR, PIT, AIR, AIT, CE, CL, DI, CRR and CRT input voltage range	Vı	-0.3 to 6.0	v
AOR, AOT, LDR, LDT, PDR1, PDR2, PDT1, PDT2, CRR and CRT output voltage range	Vo	-0.3 to 6.0	v
AOR, AOT, LDR and LDT output current range	ю	0 to 2	mA
Power dissipation	P <sub>D</sub>	350	mW
Operating temperature range	Topr	-20 to 75	∘c
Storage temperature range	T <sub>stg</sub>	55 to 125	°C

# **Recommended Operating Conditions**

 $T_a = 25 \, ^{\circ}C$ 

Parameter	Symbol	Rating	Unit
Receive-PLL supply voltage range	RV <sub>DD</sub>	2.8 to 4.5	٧
Transmit-PLL supply voltage range	TV <sub>DD</sub>	2.8 to 4.5	٧

### **Electrical Characteristics**

 $V_{DD}$  =  $RV_{DD}$  =  $TV_{DD}$  = 2.8 to 4.5 V,  $V_{SS}$  = 0 V,  $T_a$  = 25 °C unless otherwise noted

Parameter	Symbol	Condition	Rating			Unit
	Зуньог	Condition	min	typ	max	Onk
RVDD supply current	1	LM7007M. See note 1.	-	17	22	4
насо зарру сапен	Î <sub>DD1</sub>	LM7007HM. See note 1.	-	20	25	mA
RVDD + TVDD supply current		LM7007M. See note 2.	-	30	39	
TANDO + TAND Supply Curters	I <sub>DD2</sub>	LM7007MH. See note 2.	_	37	45	mA.
CE, CL, DI, CRR and CRT LOW-level input voltage	V <sub>IL</sub>		0	_	0.4	٧

# LM7007M, LM7007HM

Parameter	Symbol	Condition a		Rating		Unit
	-,	- Johanon	min	typ	max	Onit
CE, CL, DI, CRR and CRT HIGH-level input voltage	$\mathbf{V}_{IH}$		2.0	-	5.5	٧
XIN rms input voltage	Vit	Sinewave, capacitive coupling, f <sub>1</sub> = 5 to 23 MHz	50	-	1000	mV
	V <sub>12</sub>	Sinewave, capacitive coupling, f <sub>1</sub> = 200 to 400 MHz	70	-	500	
PIR and PIT rms input vollage		Sinewave, capacitive coupling, VDD = 2.8 to 3.3 V, f <sub>1</sub> = 200 to 520 MHz	100	_	500	mV
PDR1 and PDT1 LOW-level output voltage	V <sub>OL1</sub>	l <sub>O</sub> = 0.1 mA	-	-	0.3	٧
PDR2 and PDT2 LOW-level output voltage	V <sub>OL2</sub>	l <sub>0</sub> = 5 mA	-	-	1.5	٧
LDR and LDT LOW-level output voltage	Vola	l <sub>0</sub> = 1 mA	_	-	1	٧
CRR and CRT LOW-level output voltage	V <sub>OL4</sub>	I <sub>O</sub> = 2 mA, V <sub>DD</sub> = 3 V	0.7	1.0	1.4	٧
AOR and AOT LOW-level output voltage	V <sub>OL5</sub>	Io = 0.5 mA, VAIR = VAIT = 1.2 V	_	_	0.5	<del></del>
	¥0L5	Io = 1 mA, VAIR = VAIT = 1.3 V	-	-	0.5	V
PDR1 and PDT1 HIGH-level output voltage	Vohi	l <sub>O</sub> = 0.1 mA	0.6V <sub>DD</sub>	-	-	٧
PDR2 and PDT2 HIGH-level output	V <sub>OH2</sub>	I <sub>O</sub> = 0.1 mA	0.6V <sub>DD</sub>	-	-	
voltage		lo = 5 mA	0.1V <sub>DD</sub>	-	_	V
AOR, AOT, LDR, LDT, CRR and CRT oulput voltage	Vo		0	-	5.5	v
CE, CL, DI, CRR and CRT LOW-level input current	liLi	V <sub>i</sub> = 0 V	_		5	μА
XIN LOW-level input current	l <sub>IL2</sub>	V <sub>1</sub> = 0 V	1	-	6	μΑ
PIR and PIT LOW-level input current	lita	V <sub>1</sub> = 0 V	2	~	12	μА
AIR and AIT LOW-level Input current	lica	V <sub>I</sub> = 0 V	-	0.01	10.0	лА
TEST LOW-level input current	الدة	V <sub>I</sub> = 0 V	-	-	5	μА
CE, CL, DI, CRR and CRT HGH-level input current	lm	V <sub>I</sub> = 4.5 V	-		5	μА
XIN HIGH-level input current	l <sub>IH2</sub>	V <sub>1</sub> = 4.5 V	1	-	6	μΑ
PIR and PIT HIGH-level input current	fіна	V <sub>I</sub> = 4.5 V	2	-	12	μА
NR and AIT HIGH-level input current	11114	V <sub>I</sub> = 4.5 V	_	0.01	10.0	nA
FEST HIGH-level input current	lıns	V <sub>I</sub> = 4.5 V	-	225	-	μА
.DR, LDT, CRR and CRT output eakage current	l <sub>OFF1</sub>	V <sub>O</sub> = 4.5 V	-	-	5	μА
AOR and AOT output leakage current	l <sub>OFF2</sub>	Vo = 4.5 V	_	<del></del>	10	μΑ
PDR1, PDT1, PDR2 and PDT2 output eakage current	loffs	Vo = 0.4 V or 4.5 V	-	0.01	10.0	nA

## LM7007M, LM7007HM

Parameter	Symbol	= Condition		Rating		
T drumoto;	Symbol	s. Condition	min	typ	max	Unit
XIN input frequency	f <sub>l1</sub>	Sinewaye, capacitive coupling, V <sub>I</sub> = 60 mV	6	-	23	MHz
PIR and PIT input frequency		Sinewave, capacitive coupling, V <sub>I</sub> = 70 mV	200	-	400	
	f <sub>12</sub>	Sinewave, capacitive coupling, VDD = 2.8 to 3.2 V, V <sub>I</sub> = 100 mV	200	-	. 520	MHz
XIN feedback resistance	Rn	V <sub>DD</sub> = 4.5 V	750	1000	4500	kΩ
PIR and PIT feedback resistance	Re	V <sub>DD</sub> = 4.5 V	375	500	2250	kΩ
TEST pull-down resistance	Ro		-	20	-	kΩ
XIN, PIR and PIT input capacitance	Ci		-	2.5	_	pF

#### Notes

- 1.  $f_{XIN} = 12.8$  MHz,  $V_{PIR} = 70$  mV at 400 MHz, all other inputs = 0 V, all outputs open
- 2.  $f_{XIN} = 12.8$  MHz,  $V_{PIR} = V_{PIT} = 70$  mV at 400 MHz, all other inputs = 0 V, all outputs open

## **FUNCTIONAL DESCRIPTION**

#### C<sup>2</sup>B Data Format

The C<sup>2</sup>B input data format is shown in figure 1, and the input timing, in figure 2. The input data comprises 48 bits input serially on DI. TD0 is the first bit received.

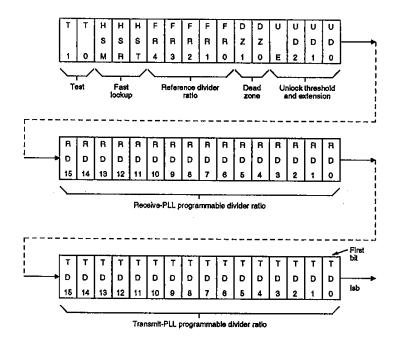


Figure 1. C2B data format

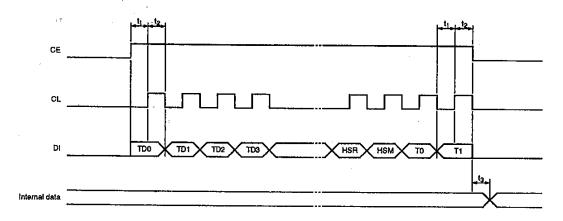


Figure 2. Serial data timing

The timing diagram parameters  $t_i$  ( $t_1$ ,  $t_2$  and  $t_3$ ) should all be greater than  $32/f_{XIN}$ , where  $f_{XIN}$  is the XIN TCXO frequency. For TCXO frequencies of 10.625, 12.8 and 21.25 MHz,  $t_i$  should be greater than 3.02, 2.5 and 1.52  $\mu$ s, respectively.

The outputs are undefined until the frequency synthesizer is programmed. The serial data should be input only after RVDD and  $f_{XIN}$  have become stable. Note that CE, CL and DI HIGH-level and LOW-level voltages are independent of RVDD.

#### Reference Divider

Data bits FR0 to FR4 set the reference frequency divider ratio. The standard temperature-compensated crystal oscillator (TXCO) input frequencies, f<sub>XIN</sub>, are 12.8, 10.625 and 21.25 MHz.

The reference divider ratios for  $f_{\rm ref}=6.25$  kHz with 12.5 kHz channel spacing for  $f_{\rm XIN}$  are shown in table 1. Table 1. Reference divider ratios

f <sub>XIN</sub> (MHz)	FR4	FR3	FR2	FR1	FR0	Divider ratio
12.8	0	0	0	0	0	2048
10.625	1	1	1	1	1	1700
21.25	0	0	1	1	1	3400

#### Unlock-detector Threshold

Data bits UD0 to UD2 determine the unlock-detector threshold. The PLL unlock-detector output,  $\overline{LDT}$  ( $\overline{LDR}$ ), is pulled LOW when the phase error between the refer-

Table 3. Unlock-detector thresholds

ence and the divided	input, $\phi_E$ , exceeds the threshold.
The threshold values	for the standard frequencies are
shown in table 3.	•

# Transmit- and Receive-PLL Programmable Dividers

Data bits TD0 to TD15 and RD0 to RD15 set the transmit- and receive-PLL programmable divider ratios, respectively. Bits TD0 and RD0 are the least significant bits.

The allowable divider ratios are in the range 256 to 65535. The PLL frequency divisions are two times the division setting of  $f_{\rm osc}/12.5$  kHz.

#### **Phase Detector**

The phase detector output states of PDT1 (PDR1) are shown in table 2. When the PLL unlocks,  $\overline{LDT}$  ( $\overline{LDR}$ ) is pulled down and PDT2 (PDR2) has the same output state as PDT1 (PDR1).

Table 2. Phase detector output states

Cond	dition	PDT1 (PDR1)
flw/N <sub>T</sub> > f <sub>ref</sub>	Leading	HIGH
f <sub>IN</sub> /N <sub>T</sub> < f <sub>ref</sub>	Lagging	LOW
f <sub>IN</sub> /N <sub>T</sub> = f <sub>ref</sub>	Coincidence	High impedance

UD2	UD1	UD0	Phase-error threshold (µs)				
		<b>JD</b>	f <sub>XIN</sub> = 12.8 MHz	f <sub>XIN</sub> = 10.625 MHz	1 <sub>XIN</sub> = 21.25 MHz		
0	0	0	0	0	0		
0	0	1	0.15	0.19	0.09		
0	1	0	0.3	illegal	0.19		

Table 3. Unlock-detector thresholds-continued

UD2	UD1	LIDO		Phase-error threshold (µs)	
UD2	1 100	UD0 —	f <sub>XIN</sub> = 12.8 MHz	f <sub>XIN</sub> = 10.625 MHz	f <sub>XIN</sub> = 21.25 MHz
0	. 1	1	Illegal	Hlegal	lllegal
1	0	0	1.25	0.94 ±0.19	0.94 ±0.19
1	0	1. ,	1.25	0.94 ±0.19	0.94 ±0.19
1	1	0	5	4.70 ±0.94	4.70 ±0.94
1	1	1	5	4.70 ±0.94	4.70 ±0.94

#### **Unlock Extension**

Data bit UE selects the unlock extension period. The period is extended by 2.5 ms, when UE = 0, and by 5 ms, when UE = 1, as shown in figure 3. The unlock extension is ignored when UD0 = UD1 = UD2 = 0.

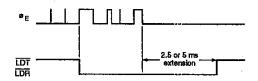


Figure 3. Unlock extension

#### Dead-zone Mode

Data bits DZO and DZ1 select the phase-insensitive bandwidth, or dead zone, of the PLL phase comparator as shown in table 4. Modes DZB, DZC and DZD have successively larger dead zones.

Table 4. Dead-zone modes

DZ1	DZ0	Dead-zone mode
0	0	lllegal
0	1	DZB
1	0	DZC
1	1	DZD

#### Fast-lockup Control

Data bits HST and HSR select fast-lockup mode for the transmit and receive PLLs, respectively. Fast-lockup mode is selected when each data bit is 1, and deselected, when 0.

Data bit HSM selects the fast-lockup operating mode as shown in figure 4. Fast-lockup operates continuously,

when HSM = 1, and during unlock only, when HSM = 0.

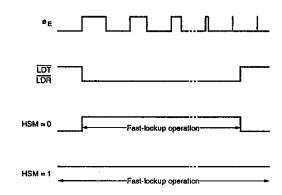


Figure 4. Fast-lockup operating modes

When fast lockup is not selected, CRT and CRR should be either open or tied to ground.

#### **Power Supply**

TVDD supplies the transmit-PLL programmable divider, phase detector, unlock detector and fast-lockup circuits. RVDD supplies the C<sup>2</sup>B interface, reference divider and receive-PLL circuits.

#### **LPF Transistors**

Open-drain transistors are provided for the transmit- and receive-PLL loop filters.

#### Test Mode (T0, T1)

Data bits T0 and T1 are normally not used and should be set to 0. Also, TEST should be open or tied to ground.

### **DESIGN INFORMATION**

# Dual Charge Pump and Fast-lockup Circuit

The dual charge pump and fast-lockup circuit is shown in figure 5. The phase detector secondary output goes active after a channel change causes the PLL to unlock. R1 becomes R1MlR1S, reducing the LPF time constant and decreasing the PLL lock time.

When the PLL locks, the phase detector secondary output becomes high impedance and R1 becomes R1M, thereby increasing the LPF time constant and improving sideband and FM response.

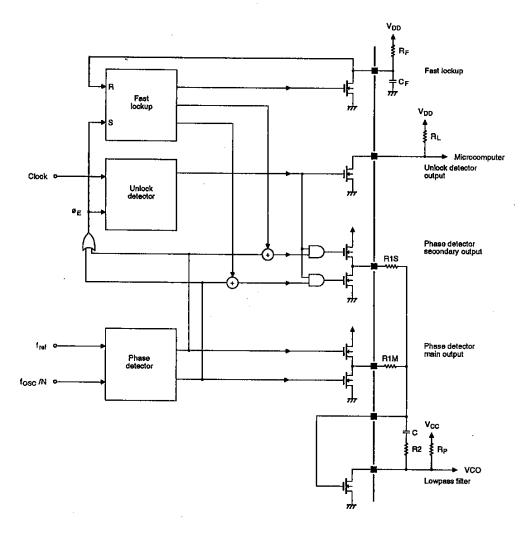


Figure 5. Dual charge pump and fast-lockup circuit

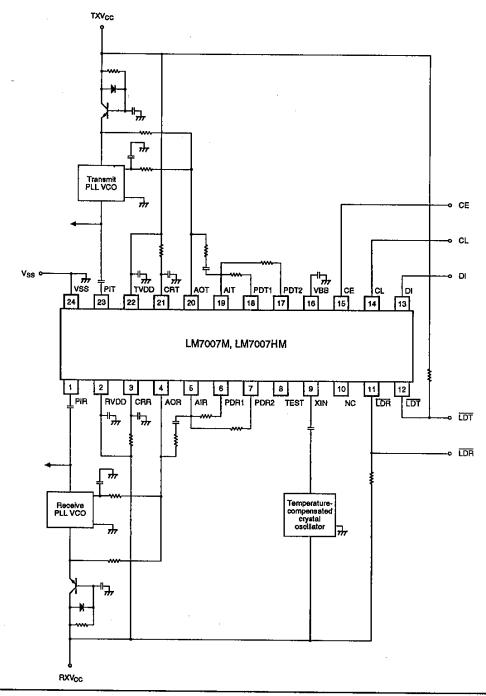
#### Phase-error Threshold

The phase-error threshold should be small during channel change to ensure precise phase-error checking and phase-detector secondary output operation. Unlocking caused by phase error is unlikely during FM operation. The phase-error threshold should be large after the PLL locks.

#### Gate Reverse Bias

A 0.01  $\mu F$  capacitor should be connected between VBB and ground for the gate reverse bias.

## TYPICAL APPLICATION



- No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster/crime-prevention equipment and the like, the failure of which may directly or indirectly cause injury, death or property loss.
- Anyone purchasing any products described or contained herein for an above-mentioned use shall:
  - ① Accept full responsibility and indemnify and defend SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors and all their officers and employees, jointly and severally, against any and all claims and litigation and all damages, cost and expenses associated with such use:
  - ② Not impose any responsibility for any fault or negligence which may be cited in any such claim or litigation on SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors or any of their officers and employees jointly or severally.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.